

### 1. Features

- Typical 1dB bandwidth of 18.9 MHz
- High attenuation
- Single Ended Operation
- Dual In-line Package (DIP)

**RoHS Compliant**

Tested by SGS Testing Korea

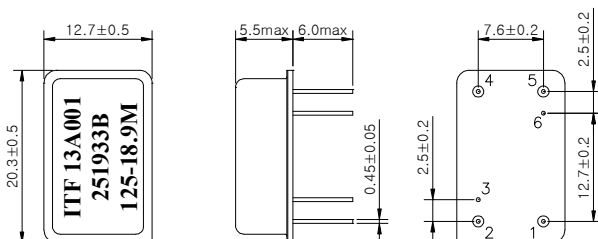
### 2. Electrical Specifications

Source and Load Impedance = 50Ω

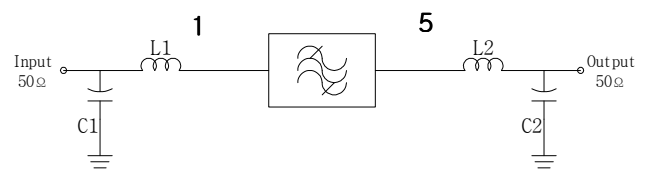
| Room Temperature : +25℃              |       | Minimum | Typical | Maximum |
|--------------------------------------|-------|---------|---------|---------|
| Center Frequency (fo)                | MHz   | 124.87  | 125.0   | 125.13  |
| Insertion Loss                       | dB    | -       | 23.7    | 25.5    |
| 1dB Bandwidth                        | MHz   | 18.80   | 18.94   | -       |
| 3dB Bandwidth                        | MHz   | -       | 19.24   | -       |
| 45dB Bandwidth                       | MHz   | -       | 20.56   | 20.65   |
| Amplitude Ripple (Fo±9.22MHz)        | dB    | -       | 0.55    | 1.0     |
| Group Delay Variation (Fo±9.22MHz)   | nsec  | -       | 45      | 100     |
| Absolute Delay                       | usec  | -       | 2.26    | 2.28    |
| Ultimate Rejection                   | dB    | 50      | 55      | -       |
| Temperature Coefficient of Frequency | ppm/℃ | -       | -72     | -       |
| Substrate Material                   | -     |         | 128-LN  |         |

\* Input POWER : 10dBm

#### D2012 Package Dimension



#### Matching Schematic



L1 = 39nH, L2 = 47nH, C1 = 36pF, C2 = 30pF

Dimensions shown are nominal in millimeters

Base : Fe(SPCC), Au plating over Ni plated  
 Cap : Cu & Cr Alloy, Ni Plated  
 Termination : Kovar, Au Plated

#### Pin Configuration

| Input  | 1 | Ground | 2,4    |
|--------|---|--------|--------|
| Output | 5 | Others | Ground |

### 3. Typical Performance ( at +25°C )

